

# PER-T356

## Environment Test Report

Report NO: 15I020022

Summary	<p><input checked="" type="checkbox"/> <b>Pass</b></p> <p><input type="checkbox"/> <b>Fail</b></p> <p>Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> <b>Pass with Deviation</b></p> <p><b>Comment:</b> _____</p>
---------	--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------

<b>Issue date</b>	<b>Approval</b>	<b>Test Engineer</b>
2015-12-01	KJ Wang	Jerry Chen

# Test item list

---

1. <i>Test item list</i> -----	2
2. <i>Configuration of EUT</i> -----	3
3. <i>Temperature rise test</i> -----	5
4. <i>Temperature cycle operation test</i> -----	9
5. <i>Cold start and hot start test</i> -----	10

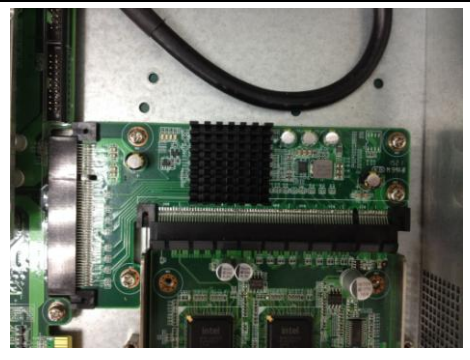

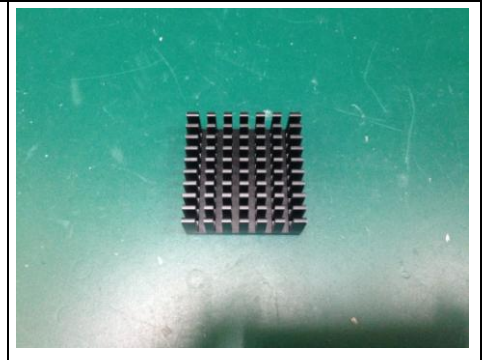
## Testing Result

Num	Test item list	Result	Remark
1	Temperature rise test	Pass	
2	Temperature cycle operation test	Pass	
3	Cold start and hot start test	Pass	

# Configuration of EUT

Num	Item	Spec
<b>1.</b>	<b>Test Product: PER-T356</b>	
	Model Name:	PER-T356 Ver. A0.2
	Board Name:	PER-T356 Ver. A0.2
	Main Chipset:	PLX.PEX8716-CA80BC G
<b>2.</b>	<b>Client (Main aid test of system)</b>	
	1. System Name	FWS-7400 Ver. A1.0
	2. Main board	FWB-7400 Ver. A1.0
	3. BIOS Ver.	FWS-7400 R1.5 (K741AM15) (06/12/2015)
	4. CPU Type	Intel Core i3-4360 3.7GHz x 4
	5. Chipset	Intel H81
	6. LAN Module	PER-C39L Ver. A0.1 x 1 (LAN Chipset – Intel 82580EB)
	7. RISER Module	PER-T356 Ver. A0.2
	8. Memory	DSL DDR3 1333 4GB CL9 (ELPID / J2108BCSE - DJ – F) x 1
	9. 2.5” SATA HDD	Toshiba / MQ01ABD032 320GB
	10. Test Software	ubuntu 14.10 / Run iPerf test
	11. Power supply	FSP / FSP250-50LC
<b>3.</b>	<b>Server (Secondary aid test of system)</b>	
	1. System Name	FWS-7811 Ver. A1.0
	2. Main board	FWB-7400 Ver. A1.0
	3. BIOS Ver.	FWS-7400 R1.5 (K741AM15) (06/12/2015)
	4. CPU Type	Intel Core i3-4360 3.7GHz x 4
	5. Chipset	Intel H81
	6. LAN Module	PER-C39L Ver. A0.1 x 1 (LAN Chipset – Intel 82580EB)
	7. RISER Module	PER-T356 Ver. A0.2
	8. Memory	Transcend DDR3 1333 U 4GB (SEC 231 HCKO K4B2G0846D) x 1
	9. 2.5” SATA HDD	Toshiba / MQ01ABD032 320GB
	10. Test Software	ubuntu 14.10 / Run iPerf test
	11. Power Supply	Zippy / R1V2-5275V4H

## Photos

Riser Module - PER-T356	LAN Module - PER-C39L	Chipset Heat Sink
 A photograph of a green printed circuit board (PCB) riser module. It features a large black multi-pin connector on the left side and several integrated circuits and components on the board. The module is shown in a perspective view, partially inserted into a metal chassis.	 A photograph of a green PCB LAN module. It has a prominent black multi-pin connector on the left and a central square chip. The module is shown in a perspective view, partially inserted into a metal chassis.	 A close-up photograph of a square, black, grid-patterned heat sink. It is mounted on a green PCB, which is visible in the background.

# Temperature rise test

**Test Date:** 11-26 ~ 27-2015

**Test Product:** PER-T356 with PER-C39L and FWS-7400

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to EN 61131-2(94), UL508 (94)

**Temperature Measurement:**

40 Channel Thermal Recorder:

YOKOGAWA Inc,

Model: DA100-13-1D

Date of Calibration: 09/10/2015

Serial Number: 12A323190

**Test Condition:**

Ambient temperature: 40°C

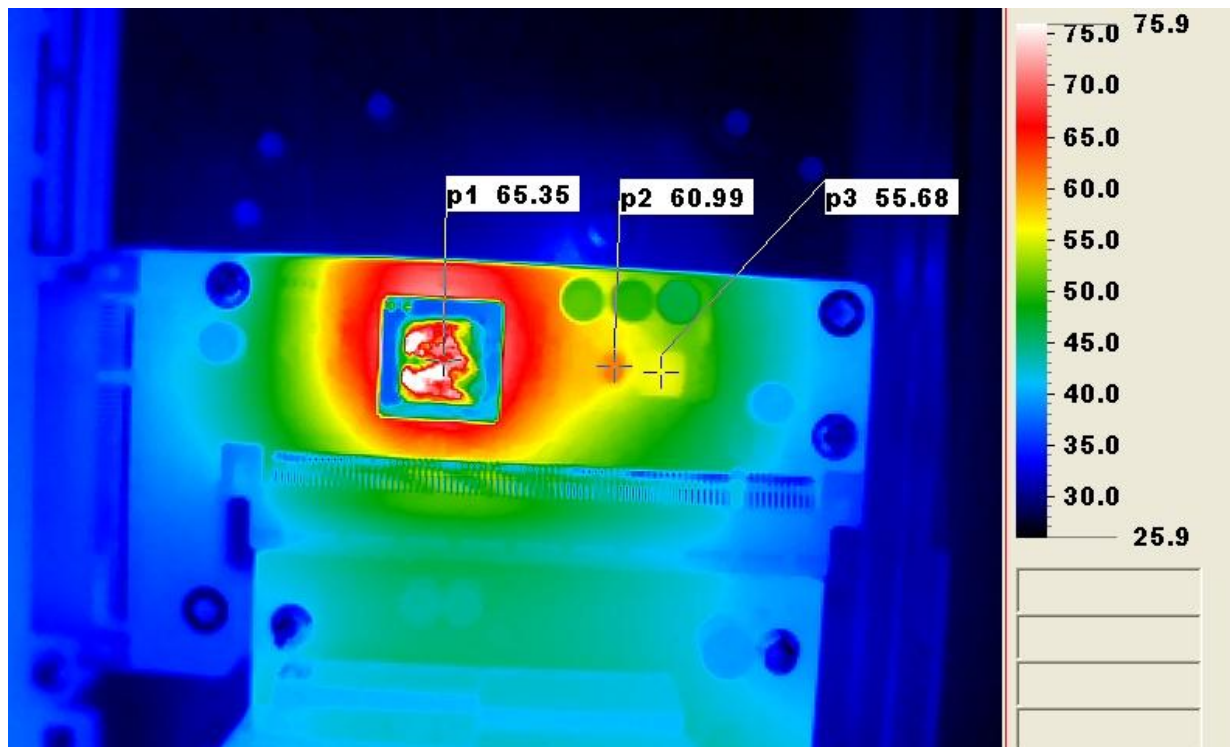
Continuous running till thermal stable (within less than 1°C)

**Test Software:**

ubuntu 14.10 / Run iPerf test

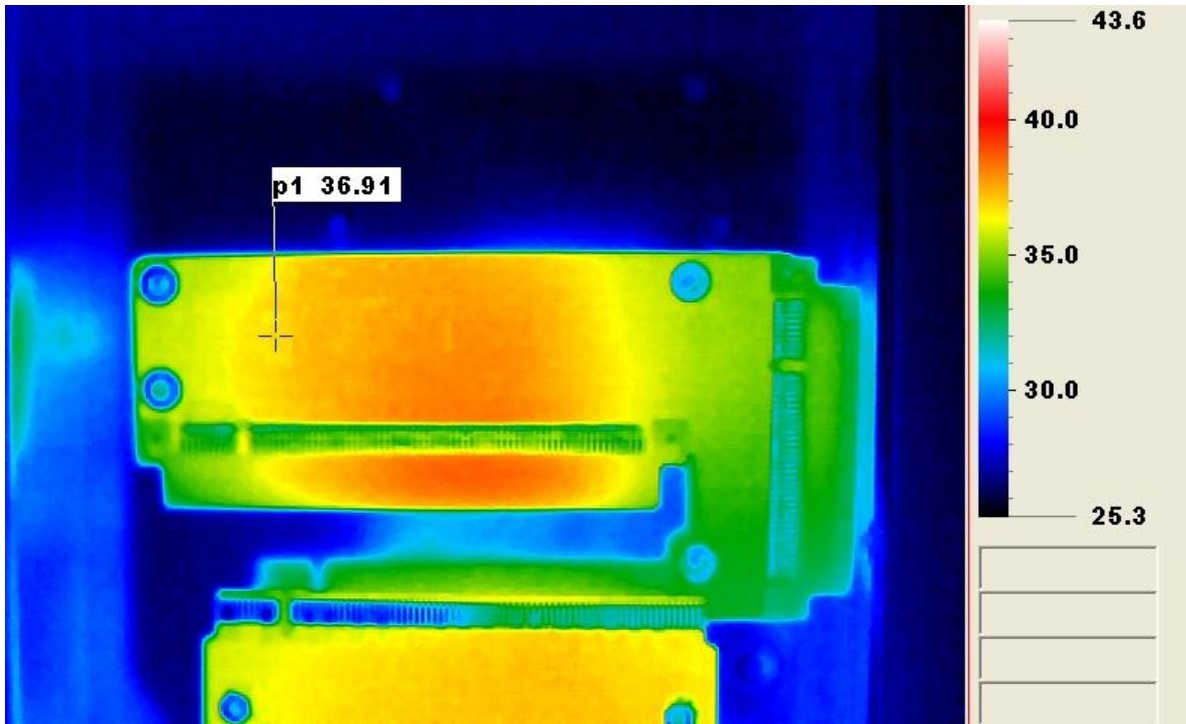
**Terminal Recorder:**

**Front Side:**



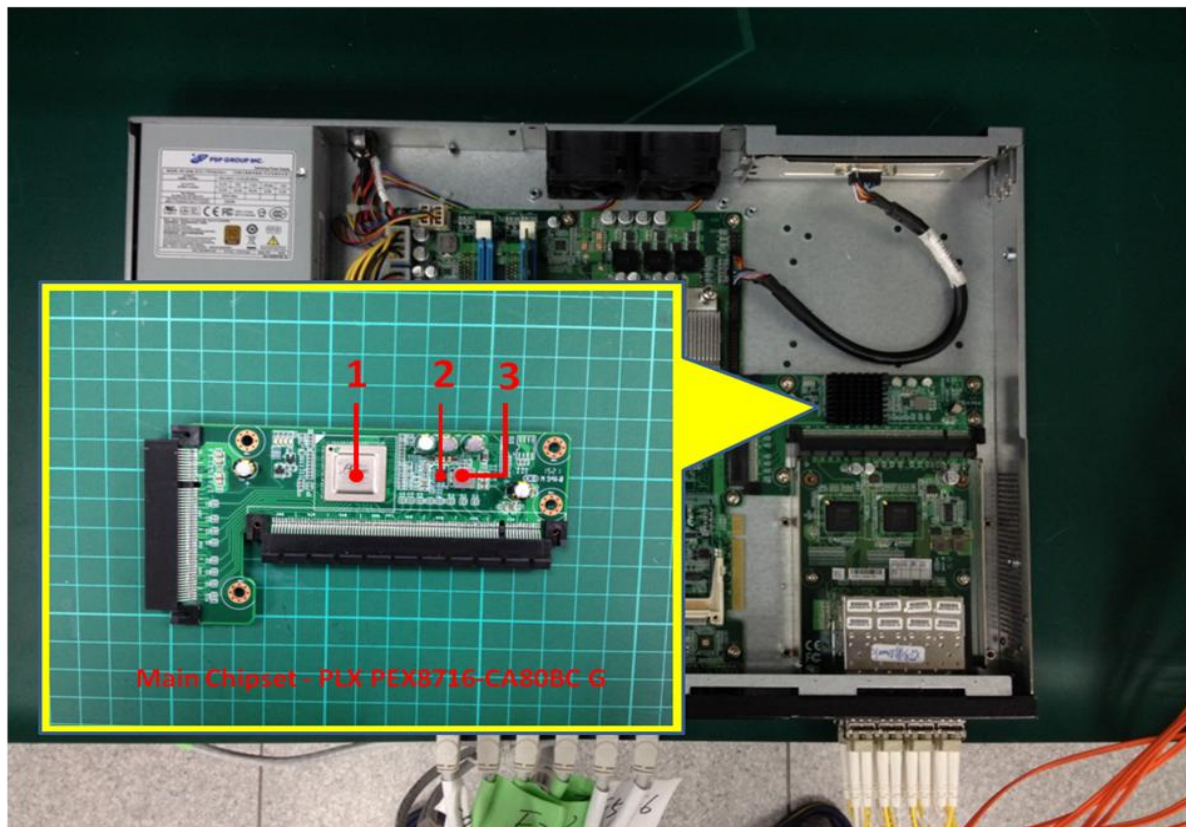
# Temperature rise test

Rear Side:



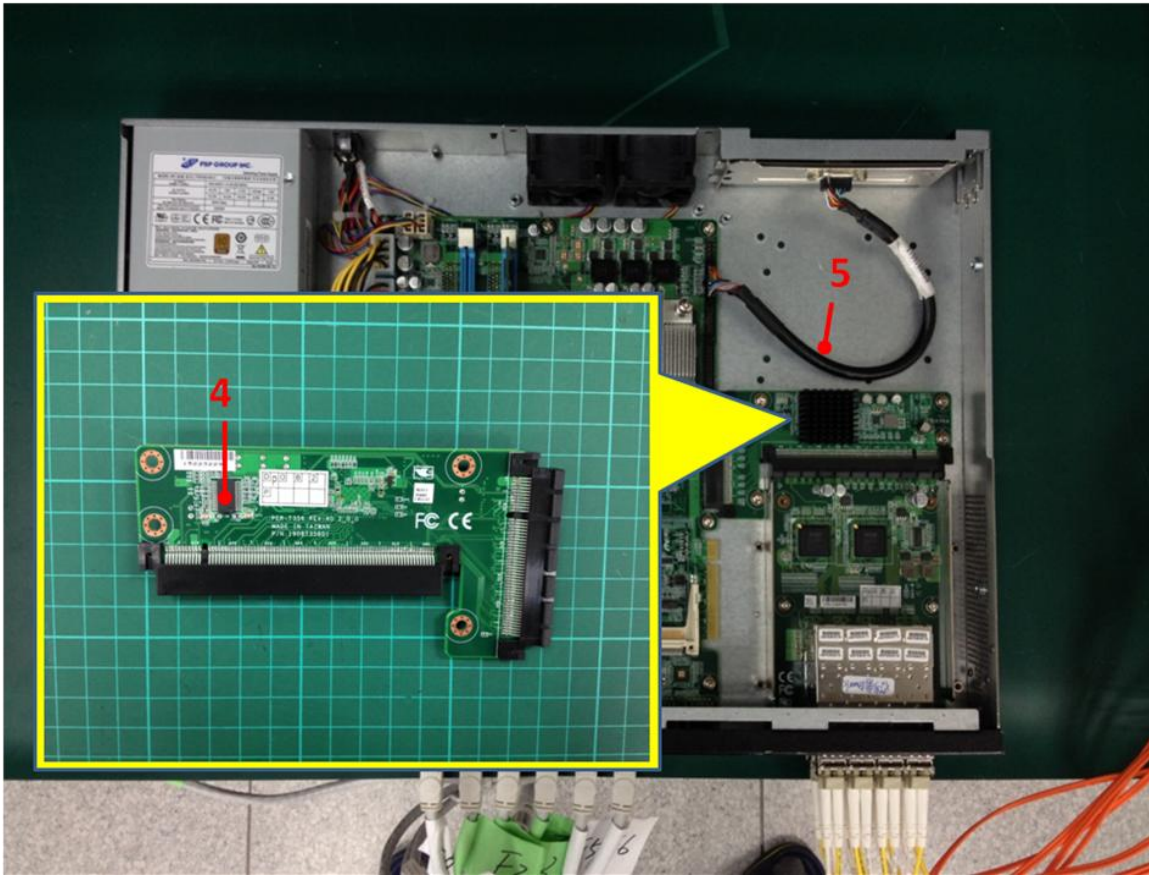
Measuring Thermal Couple Position :

Front Side:



# Temperature rise test

Rear Side:



# Temperature rise test

Thermal profile data:

PER-T356 with PER-C39L and FWS-7400

Point	Position	Describe	Tc (*1) (°C)	TAT(*2)		TPT(*3)	Note
				40°C	25°C		
1	U1	IC.PCIe-PCIe Bridge.FCBGA 324Pin.PLX.PEX8716-CA80BC G	85	79.5	64.5		
2	U5	IC.10A.Synchronous Step down.QFN16.3X4mm.MPS.MP8762GLE-Z	100	65.1	50.1		
3	L1	COIL.1.5uH.Idc=10A.DCR=10.6mohm.CYNTEC.PCMB063T-1R5MS	140	61.2	46.2		
4	U6	IC.SMD SSOP 28P.Clock Buffer.ICS.ICS9DB104FLFT	115	58.9	43.9		
5	N/A	Control Box Inside Air Temperature	N/A	41	26		
6	N/A	Control Box External Surface Temperature	N/A	39.9	24.9		
7	N/A	Chamber Air Temperature	N/A	40	25		

Note(\*):

- "Tc" indicates the component's case maximum temperature value specified in its datasheet.
- "TAT" indicates the actual measured temperature under product specification.
- "TPT" indicates the predicted temperature under 25°C working environmental.
- "Tm" indicates the measured Tc value under working environmental temperature within product specification.

**5. Judgment Criteria:**

- **Fail** :  $T_m > T_c$ ; The measured value is over specification plus margin.
- **Margin** :  $T_c > T_m > T_c - 5^\circ\text{C}$ ; The measured value is within specification with margin.  
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
- **Pass** :  $T_m < T_c - 5^\circ\text{C}$ ; The measured value is with safety margin.

**4. Defect NO.**



# Temperature cycle test

**Test Date:** 11-23 ~ 25-2015

**Test Product:** PER-T356 with PER-C39L and FWS-7400

**Test Site:** AAEON QE Dept.

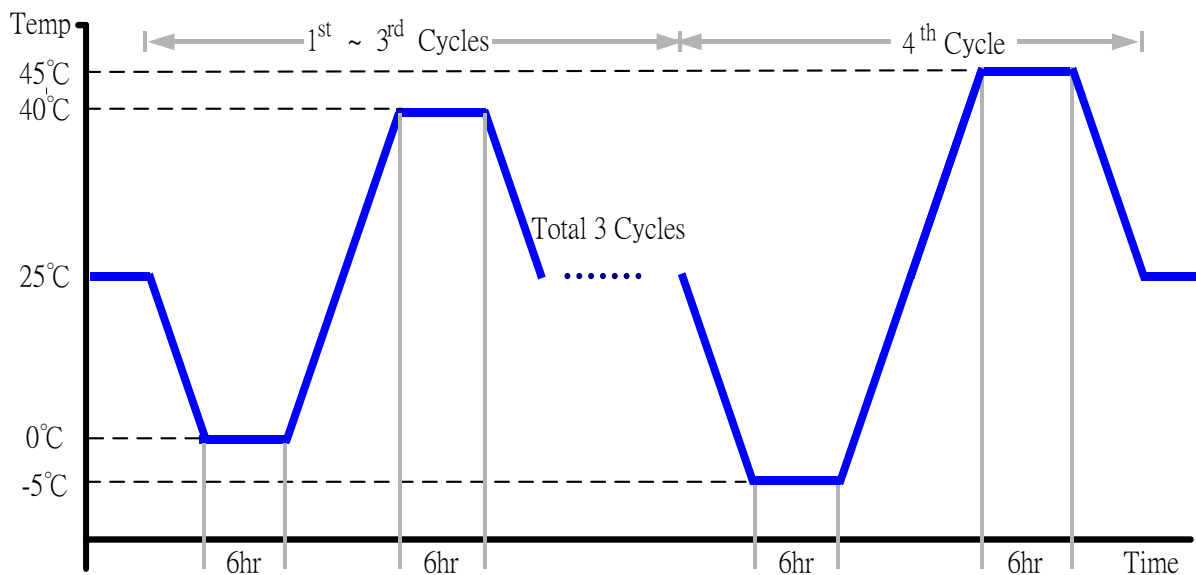
**Test Standard:** Refer to IEC68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**

Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)  
Model: THS-D4H + - 100  
Date of Calibration: 11/13/2015  
Serial Number: 2582

**Test Condition:**

1. Test Low Temperature: 0°C (1~3 cycles)  
-5°C (4<sup>th</sup> cycle)
2. Test High Temperature: 40°C (1~3 cycles)  
45°C (4<sup>th</sup> cycle)
3. Test dwell time: 6Hrs
4. Temperature slope: 2°C/min
5. Test cycle: 4 cycles
6. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (PER-T356)

**Test Result:**

No issues were found during the temperature operation cycle test.

# Cold start and hot start test

**Test Date:** 11-25 ~ 26-2015

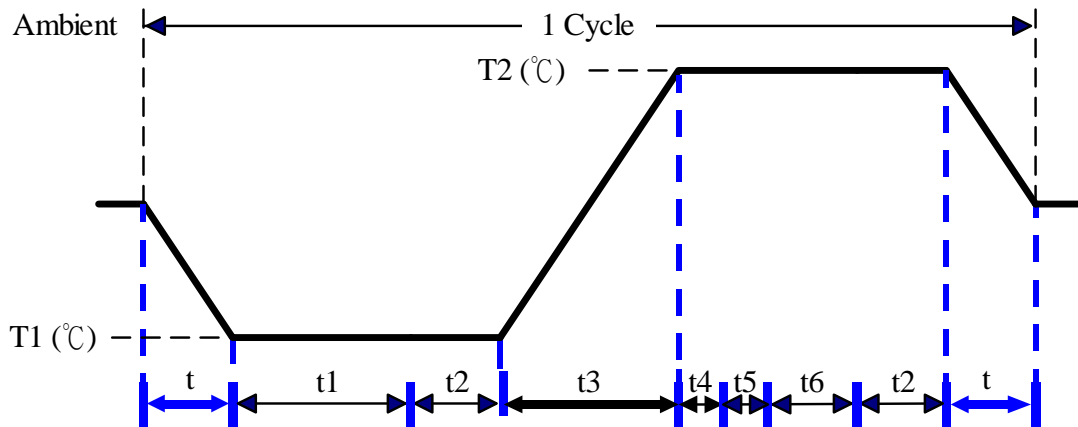
**Test Product:** PER-T356 with PER-C39L and FWS-7400

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**  
Programmable Temperature & Humidity Chamber: (K.SON. INS. TECH. CORP.)  
Model: THS-D4H + - 100  
Date of Calibration: 11/13/2015  
Serial Number: 2582

**Test Condition:**



Parameters	Description
T1	-5°C
T2	45°C
t1	4 hrs
t2, t6	2 hrs
t4, t5	1hrs
t, t3	2°C/min
n (Cycle)	1

t = temprature slope  
t , t1, t6: Power Off  
t2: Power on/off test 10 times (on 2 min / off 5min)  
t3, t4: Run iPerf test  
t5: ubuntu 14.10 Software restart test 3 times  
Test Software: ubuntu 14.10

**Test Result:**

- a. No issues were found during the cold start test.
- b. No issues were found during the hot start test.